

SF-P111-E

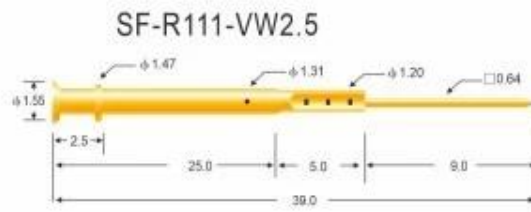
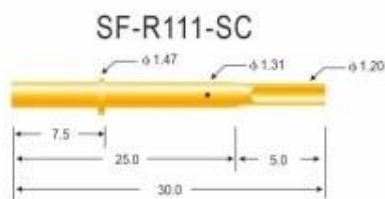
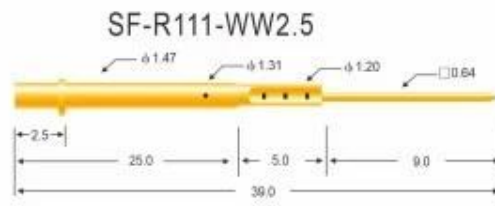
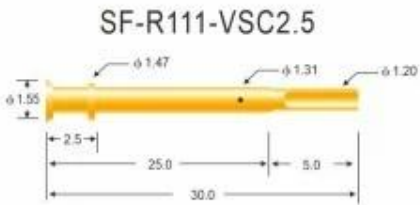
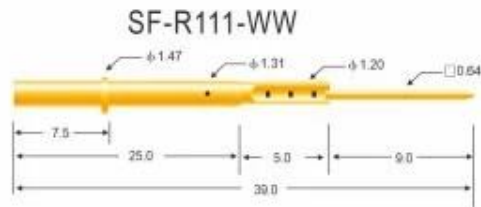
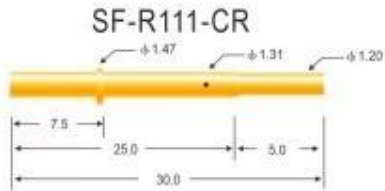
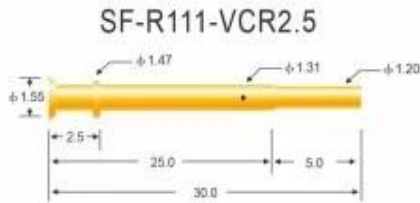
技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.90mm(.0748 ")
Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Full travel 行程	6.3(.2481 ")
Spring force 弹簧压力	120g(克)
Materials and finishes 材料及涂饰	Plunger:SK4, Ni or Au plated BeCu, Ni or Au plated Phosphor bronze, Ni or Au plated Barrel:Phosphor bronze, Au plated Spring:Stainless steel
Current ration 额定电流	3A(安培)
Contact resistance 接触电阻	50mΩ(毫欧姆)

Receptacle specifications
Materials and finishes: Phosphor bronze,Gold plated

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Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Materials and finishes 材料及涂饰	Barrel: Brass, Au plated
Connections 接线形式	Crimp: R111-VCR2.5, R111-CR Solder cup: R111-VSC2.5, R111-SC Wire wrap: R111-VW2.5, R111-WW2.5, R111-WW Terminal:



1. □□□□□□24□□□□□□□□□□
2. □□□□□□□□□□OEM□
3. □□□□□□□□□□□□□□□□□□□□
4. □□□□□□□□□□□□□□□□□□□□



1. 物料管理/PCB/ICT/FCT
2. Pogo pin
3. BGA
4. QZ/VZ/LM
- 5.
- 6.
7. 30#OK/POM

物料管理/PCB/ICT/FCT



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products



6. Packing



A5: [Placeholder]

Q6. [Placeholder]

A6: [Placeholder]

Q7. [Placeholder] **OEM** [Placeholder] **ODM** [Placeholder]

A7: [Placeholder] OEM/ODM [Placeholder]

Q8. [Placeholder]

A8: [Placeholder]